

S-1000 Series

ULTRA-SMALL PACKAGE HIGH-PRECISION VOLTAGE DETECTOR

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Rev.3.1_02

The S-1000 series is a series of high-precision voltage detectors developed using CMOS process. The detection voltage is fixed internally with an accuracy of $\pm 1.0\%$. It operates with low current consumption of 350 nA typ. Two output forms, Nch open-drain and CMOS output, are available. CMOS voltage detector, S-1000 Series is the most suitable for the portable equipments with ultra low current consumption, high precision and corresponding to the small package.

Features

- Ultra-low current consumption 350 nA ty
 - 350 nA typ. (V_{DD} = detection voltage + 1.5 V) \pm 1.0%
- High-precision detection voltage
- Operating voltage range
- Hysteresis characteristics
- Detection voltage
- Output form

5% typ. 1.5 to 4.6 V (0.1 V step) Nch open-drain output (Active "L") CMOS output (Active "L")

0.95 to 5.5 V

- Lead-free, Sn 100%, halogen-free^{*1}
- *1. Refer to "
 Product Name Structure" for details.

Applications

- Power monitor for microcomputers and reset for CPUs.
- Power monitor for portable equipments such as cellular phones, digital still cameras and PDAs.
- Constant voltage power monitor for cameras, video equipments and communication devices.

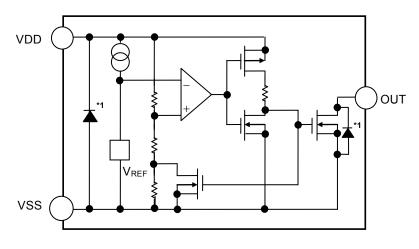
Packages

- SC-82AB
- SOT-23-5
- SNT-4A



Block Diagrams

1. Nch open-drain output products

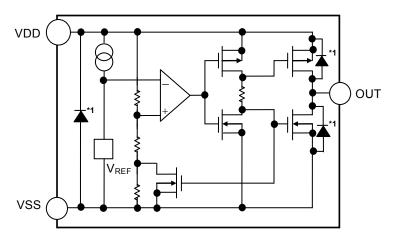


Rev.3.1_02

*1. Parasitic diode

Figure 1

2. CMOS output products



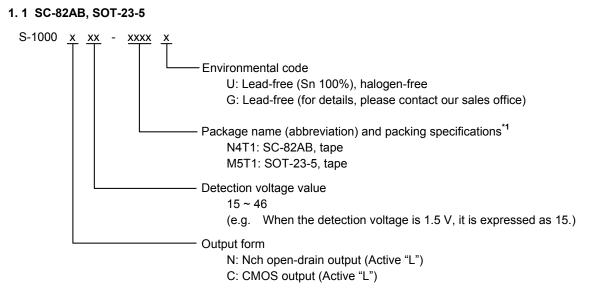
*1. Parasitic diode



Product Name Structure

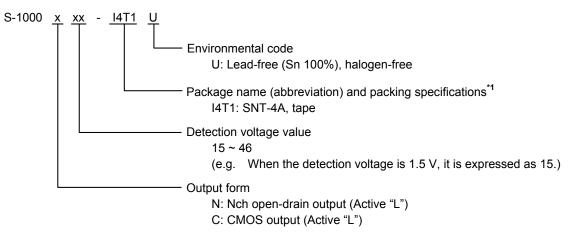
The detection voltage, output form and packages for S-1000 series can be selected at the user's request. Refer to the "1. **Product name**" for the construction of the product name, "2. **Package**" regarding the package drawings and "3. **Product name list**" for the full product names.

1. Product name



*1. Refer to the taping specifications at the end of this book.

1.2 SNT-4A



*1. Refer to the taping specifications at the end of this book.

2. Packages

Deekage nome		Drawing code					
Package name	Package	Таре	Reel	Land			
SC-82AB	NP004-A-P-SD	NP004-A-C-SD NP004-A-C-S1	NP004-A-R-SD	-			
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD	-			
SNT-4A	PF004-A-P-SD	PF004-A-C-SD	PF004-A-R-SD	PF004-A-L-SD			

3. Product name list

3.1 Nch open-drain output products

Table 1						
Detection voltage range	SC-82AB	SOT-23-5	SNT-4A			
$1.5~V\pm1.0\%$	S-1000N15-N4T1x	S-1000N15-M5T1x	S-1000N15-I4T1U			
$1.6~V\pm1.0\%$	S-1000N16-N4T1x	S-1000N16-M5T1x	S-1000N16-I4T1U			
$1.7~V\pm1.0\%$	S-1000N17-N4T1x	S-1000N17-M5T1x	S-1000N17-I4T1U			
$1.8~V\pm1.0\%$	S-1000N18-N4T1x	S-1000N18-M5T1x	S-1000N18-I4T1U			
$1.9~V\pm1.0\%$	S-1000N19-N4T1x	S-1000N19-M5T1x	S-1000N19-I4T1U			
$2.0~V\pm1.0\%$	S-1000N20-N4T1x	S-1000N20-M5T1x	S-1000N20-I4T1U			
$2.1~V\pm1.0\%$	S-1000N21-N4T1x	S-1000N21-M5T1x	S-1000N21-I4T1U			
$2.2~V\pm1.0\%$	S-1000N22-N4T1x	S-1000N22-M5T1x	S-1000N22-I4T1U			
$2.3~V\pm1.0\%$	S-1000N23-N4T1x	S-1000N23-M5T1x	S-1000N23-I4T1U			
$2.4~\text{V}\pm1.0\%$	S-1000N24-N4T1x	S-1000N24-M5T1x	S-1000N24-I4T1U			
$2.5~V\pm1.0\%$	S-1000N25-N4T1x	S-1000N25-M5T1x	S-1000N25-I4T1U			
$2.6~V\pm1.0\%$	S-1000N26-N4T1x	S-1000N26-M5T1x	S-1000N26-I4T1U			
$2.7~V\pm1.0\%$	S-1000N27-N4T1x	S-1000N27-M5T1x	S-1000N27-I4T1U			
$2.8~V\pm1.0\%$	S-1000N28-N4T1x	S-1000N28-M5T1x	S-1000N28-I4T1U			
$2.9~V\pm1.0\%$	S-1000N29-N4T1x	S-1000N29-M5T1x	S-1000N29-I4T1U			
$3.0~V\pm1.0\%$	S-1000N30-N4T1x	S-1000N30-M5T1x	S-1000N30-I4T1U			
$3.1~V\pm1.0\%$	S-1000N31-N4T1x	S-1000N31-M5T1x	S-1000N31-I4T1U			
$3.2~V\pm1.0\%$	S-1000N32-N4T1x	S-1000N32-M5T1x	S-1000N32-I4T1U			
$3.3~V\pm1.0\%$	S-1000N33-N4T1x	S-1000N33-M5T1x	S-1000N33-I4T1U			
$3.4~V\pm1.0\%$	S-1000N34-N4T1x	S-1000N34-M5T1x	S-1000N34-I4T1U			
$3.5~V\pm1.0\%$	S-1000N35-N4T1x	S-1000N35-M5T1x	S-1000N35-I4T1U			
$3.6~V\pm1.0\%$	S-1000N36-N4T1x	S-1000N36-M5T1x	S-1000N36-I4T1U			
$3.7~V\pm1.0\%$	S-1000N37-N4T1x	S-1000N37-M5T1x	S-1000N37-I4T1U			
$3.8~V\pm1.0\%$	S-1000N38-N4T1x	S-1000N38-M5T1x	S-1000N38-I4T1U			
$3.9~V\pm1.0\%$	S-1000N39-N4T1x	S-1000N39-M5T1x	S-1000N39-I4T1U			
$4.0~V\pm1.0\%$	S-1000N40-N4T1x	S-1000N40-M5T1x	S-1000N40-I4T1U			
$4.1~\text{V}\pm1.0\%$	S-1000N41-N4T1x	S-1000N41-M5T1x	S-1000N41-I4T1U			
$4.2~V\pm1.0\%$	S-1000N42-N4T1x	S-1000N42-M5T1x	S-1000N42-I4T1U			
$4.3~V\pm1.0\%$	S-1000N43-N4T1x	S-1000N43-M5T1x	S-1000N43-I4T1U			
$4.4~\text{V}\pm1.0\%$	S-1000N44-N4T1x	S-1000N44-M5T1x	S-1000N44-I4T1U			
$4.5~V\pm1.0\%$	S-1000N45-N4T1x	S-1000N45-M5T1x	S-1000N45-I4T1U			
$4.6~\text{V}\pm1.0\%$	S-1000N46-N4T1x	S-1000N46-M5T1x	S-1000N46-I4T1U			
Pomark 1 v: Corll						

Remark 1. x: G or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

3. 2 CMOS output products

Table 2								
Detection voltage range	SC-82AB	SOT-23-5	SNT-4A					
$1.5 \ V \pm 1.0\%$	S-1000C15-N4T1x	S-1000C15-M5T1x	S-1000C15-I4T1U					
1.6 V ± 1.0%	S-1000C16-N4T1x	S-1000C16-M5T1x	S-1000C16-I4T1U					
1.7 V ± 1.0%	S-1000C17-N4T1x	S-1000C17-M5T1x	S-1000C17-I4T1U					
1.8 V ± 1.0%	S-1000C18-N4T1x	S-1000C18-M5T1x	S-1000C18-I4T1U					
1.9 V ± 1.0%	S-1000C19-N4T1x	S-1000C19-M5T1x	S-1000C19-I4T1U					
$2.0 \ V \pm 1.0\%$	S-1000C20-N4T1x	S-1000C20-M5T1x	S-1000C20-I4T1U					
2.1 V ± 1.0%	S-1000C21-N4T1x	S-1000C21-M5T1x	S-1000C21-I4T1U					
$2.2~V\pm1.0\%$	S-1000C22-N4T1x	S-1000C22-M5T1x	S-1000C22-I4T1U					
$2.3~V\pm1.0\%$	S-1000C23-N4T1x	S-1000C23-M5T1x	S-1000C23-I4T1U					
$2.4~V\pm1.0\%$	S-1000C24-N4T1x	S-1000C24-M5T1x	S-1000C24-I4T1U					
$2.5~V\pm1.0\%$	S-1000C25-N4T1x	S-1000C25-M5T1x	S-1000C25-I4T1U					
$2.6~V\pm1.0\%$	S-1000C26-N4T1x	S-1000C26-M5T1x	S-1000C26-I4T1U					
$2.7~V\pm1.0\%$	S-1000C27-N4T1x	S-1000C27-M5T1x	S-1000C27-I4T1U					
$2.8~V\pm1.0\%$	S-1000C28-N4T1x	S-1000C28-M5T1x	S-1000C28-I4T1U					
$2.9~V\pm1.0\%$	S-1000C29-N4T1x	S-1000C29-M5T1x	S-1000C29-I4T1U					
$3.0~V\pm1.0\%$	S-1000C30-N4T1x	S-1000C30-M5T1x	S-1000C30-I4T1U					
$3.1~V\pm1.0\%$	S-1000C31-N4T1x	S-1000C31-M5T1x	S-1000C31-I4T1U					
$3.2~V\pm1.0\%$	S-1000C32-N4T1x	S-1000C32-M5T1x	S-1000C32-I4T1U					
$3.3~V\pm1.0\%$	S-1000C33-N4T1x	S-1000C33-M5T1x	S-1000C33-I4T1U					
$3.4~V\pm1.0\%$	S-1000C34-N4T1x	S-1000C34-M5T1x	S-1000C34-I4T1U					
$3.5~V\pm1.0\%$	S-1000C35-N4T1x	S-1000C35-M5T1x	S-1000C35-I4T1U					
$3.6~V\pm1.0\%$	S-1000C36-N4T1x	S-1000C36-M5T1x	S-1000C36-I4T1U					
$3.7~V\pm1.0\%$	S-1000C37-N4T1x	S-1000C37-M5T1x	S-1000C37-I4T1U					
$3.8~V\pm1.0\%$	S-1000C38-N4T1x	S-1000C38-M5T1x	S-1000C38-I4T1U					
$3.9~V\pm1.0\%$	S-1000C39-N4T1x	S-1000C39-M5T1x	S-1000C39-I4T1U					
$4.0~V\pm1.0\%$	S-1000C40-N4T1x	S-1000C40-M5T1x	S-1000C40-I4T1U					
$4.1~\text{V}\pm1.0\%$	S-1000C41-N4T1x	S-1000C41-M5T1x	S-1000C41-I4T1U					
$4.2~V\pm1.0\%$	S-1000C42-N4T1x	S-1000C42-M5T1x	S-1000C42-I4T1U					
$4.3~V\pm1.0\%$	S-1000C43-N4T1x	S-1000C43-M5T1x	S-1000C43-I4T1U					
4.4 V ± 1.0%	S-1000C44-N4T1x	S-1000C44-M5T1x	S-1000C44-I4T1U					
$4.5~V\pm1.0\%$	S-1000C45-N4T1x	S-1000C45-M5T1x	S-1000C45-I4T1U					
4.6 V ± 1.0%	S-1000C46-N4T1x	S-1000C46-M5T1x	S-1000C46-I4T1U					

Remark 1. x: G or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

Output Forms

1. Output forms in S-1000 series

	Nch open-drain output products (Active "L")	CMOS output products (Active "L")
S-1000 series	"N" is the last letter of the product name. e.g. S-1000N	"C" is the last letter of the product name. e.g. S-1000C

Table 3

2. Output form and their usage

	Table 4	
Usage	Nch open-drain output products (Active "L")	CMOS output products (Active "L")
Different power supplies	Yes	No
Active "L" reset for CPUs	Yes	Yes
Active "H" reset for CPUs	No	No
Detection voltage change by resistor divider	Yes	No

• Example for two power supplies

• Example for one power supply

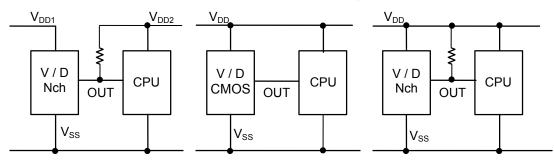


Figure 3

Pin Configurations

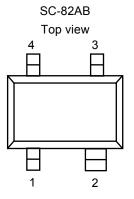


Figure 4

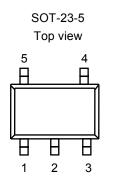


Figure 5

SNT-4A Top view

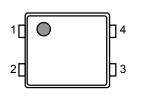


Figure 6

Table 5						
Pin No.	Pin name	Pin description				
1	OUT	Voltage detection output pin				
2	VDD	Voltage input pin				
3	NC ^{*1}	No connection				
4	VSS	GND pin				

***1.** The NC pin is electrically open.

The NC pin can be connected to VDD or VSS.

Table 6

Pin name	Pin description
OUT	Voltage detection output pin
VDD	Voltage input pin
VSS	GND pin
NC ^{*1}	No connection
NC ^{*1}	No connection
	OUT VDD VSS NC ^{*1}

*1. The NC pin is electrically open.

The NC pin can be connected to VDD or VSS.

Table 7

Pin No.	Pin name	Pin description
1	OUT	Voltage detection output pin
2	VSS	GND pin
3	NC ^{*1}	No connection
4	VDD	Voltage input pin

*1. The NC pin is electrically open.

The NC pin can be connected to VDD or VSS.

Absolute Maximum Ratings

			(Ta = 25 °C unless otherwise spe	ecified)
	Item	Symbol	Absolute maximum ratings	Unit
Power supply volta	age	$V_{\text{DD}} - V_{\text{SS}}$	6	V
Output voltage	Nch open-drain output products	V	$V_{SS} - 0.3$ to $V_{SS} + 6$	V
Output voltage	CMOS output products	V _{OUT}	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Output current		I _{OUT}	50	mA
	SC-82AB		200 (When not mounted on board)	mW
	3C-02AB		350 ^{*1}	mW
Power dissipation	SOT-23-5	PD	300 (When not mounted on board)	mW
	301-23-5		600 ^{*1}	mW
	SNT-4A		300 ^{*1}	mW
Operating ambient temperature		T _{opr}	-40 to +85	°C
Storage temperature		T _{stg}	-40 to +125	°C

Table 8

*1. When mounted on board

[Mounted board]

(1) Board size: $114.3 \text{ mm} \times 76.2 \text{ mm} \times t1.6 \text{ mm}$

(2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

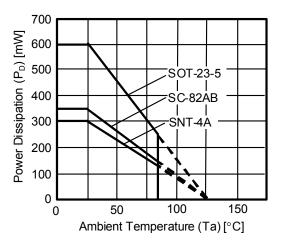


Figure 7 Power Dissipation of Package (When Mounted on Board)

Electrical Characteristics

1. Nch open-drain output products

Table 9

				(Ta =	25 °C ur	less oth	erwise	specified
ltem	Symbol	Condition		Min.	Тур.	Max.	Unit	Measure ment circuit
Detection voltage ^{*1}	$-V_{DET}$	_		$\begin{array}{c} -V_{\text{DET(S)}} \\ \times 0.99 \end{array}$	-V _{DET(S)}	-V _{DET(S)} ×1.01	V	1
Hysteresis width	V _{HYS}	_		-V _{DET} ×0.03	-V _{DET} ×0.05	-V _{DET} ×0.07	V	1
Current consumption		$V_{DD} = -V_{DET(S)} + 1.5 \text{ V}$	S-1000N15 to 39	_	350	900	nA	2
Current consumption I _{SS}		$V_{DD} = 5.5 V$	S-1000N40 to 46	_	350	900	nA	2
Operating voltage	V _{DD}	-		0.95	_	5.5	V	1
Output current	I _{OUT}	Output transistor, Nch, V _{DS} = 0.5 V, V _{DD} = 1.2 V		1.36	2.55	_	mA	3
Leakage current	I _{LEAK}	Output transistor, Nch, V _{DS} = 5.5 V, V _{DD} = 5.5 V		_	-	100	nA	3
Response time	t _{PLH}	-		—	—	60	μS	1
Detection voltage temperature coefficient ^{*2}	$\frac{\Delta - V_{\text{DET}}}{\Delta T a \bullet - V_{\text{DET}}}$	Ta = −40 to +85 °C		_	±100	±350	ppm / °C	1

*1. -V_{DET}: Actual detection voltage value, -V_{DET(S)}: Specified detection voltage value (The center value of the detection voltage range in **Table 1**.)

*2. The temperature change ratio in the detection voltage [mV / °C] is calculated by using the following equation.

$$\frac{\Delta - V_{\text{DET}}}{\Delta Ta} \left[\text{mV}/^{\circ}\text{C} \right]^{*1} = -V_{\text{DET}(S)} (\text{Typ.}) \left[\text{V} \right]^{*2} \times \frac{\Delta - V_{\text{DET}}}{\Delta Ta \bullet - V_{\text{DET}}} \left[\text{ppm}/^{\circ}\text{C} \right]^{*3} \div 1000$$

*1. Temperature change ratio of the detection voltage

*2. Specified detection voltage

*3. Detection voltage temperature coefficient

ULTRA-SMALL PACKAGE HIGH-PRECISION VOLTAGE DETECTOR S-1000 Series

Rev.3.1_02

2. CMOS output products

Table 10

(Ta = 25 °C unless otherwise specified)								
ltem	Symbol	Condition		Min.	Тур.	Max.	Unit	Measure- ment circuit
Detection voltage ^{*1}	$-V_{DET}$	_		$\begin{array}{c} -V_{\text{DET(S)}} \\ \times 0.99 \end{array}$	-V _{DET(S)}	$\begin{array}{c} -V_{DET(S)} \\ \times 1.01 \end{array}$	V	1
Hysteresis width	V _{HYS}	_		-V _{DET} ×0.03	-V _{DET} ×0.05	−V _{DET} ×0.07	V	1
Current concurrention	I	$V_{DD} = -V_{DET(S)} + 1.5 V$	S-1000C15 to 39		350	900	nA	2
Current consumption	I _{SS}	$V_{DD} = 5.5 V$	S-1000C40 to 46		350	900	nA	2
Operating voltage	V_{DD}	-		0.95		5.5	V	1
		Output transistor, Nch, $V_{DS} = 0.5 V$, V_{D}	_D = 1.2 V	1.36	2.55	-	mA	3
Output current I _{OUT} Output transistor		Output transistor, Pch, V _{DS} = 0.5 V, V _D	_D = 5.5 V	1.71	2.76	_	mA	4
Response time	t _{PLH}	_		-	-	60	μS	1
Detection voltage temperature coefficient ^{*2}	$\frac{\Delta - V_{\text{DET}}}{\Delta T a \bullet - V_{\text{DET}}}$	Ta = -40 to +85 °C		_	±100	±350	ppm/ °C	1

*1. -V_{DET}: Actual detection voltage value, -V_{DET(S)}: Specified detection voltage value (The center value of the detection voltage range in **Table 2**.)

*2. The temperature change ratio in the detection voltage [mV / °C] is calculated by using the following equation.

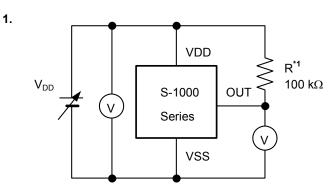
$$\frac{\Delta - V_{\text{DET}}}{\Delta Ta} \left[\text{mV/°C} \right]^{*1} = -V_{\text{DET}(S)} (\text{Typ.}) \left[V \right]^{*2} \times \frac{\Delta - V_{\text{DET}}}{\Delta Ta \bullet - V_{\text{DET}}} \left[\text{ppm/°C} \right]^{*3} \div 1000$$

*1. Temperature change ratio of the detection voltage

*2. Specified detection voltage

*3. Detection voltage temperature coefficient

Measurement Circuits



1. R is unnecessary for CMOS output products.

Figure 8

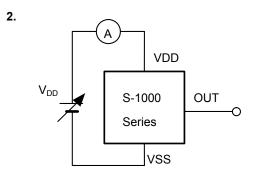


Figure 9

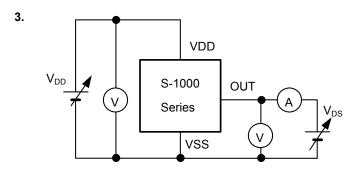


Figure 10

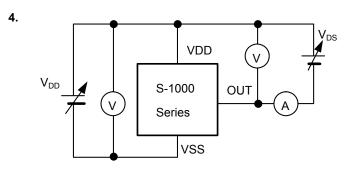
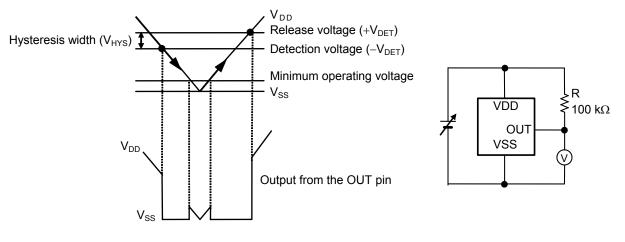


Figure 11

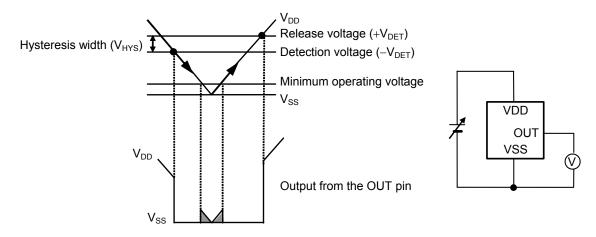
Timing Chart

1. Nch open-drain output products





2. CMOS output products

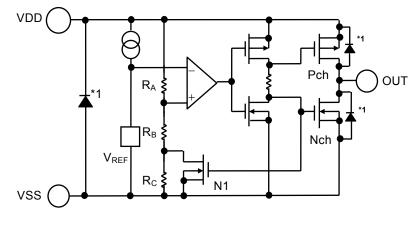


Remark For values of V_{DD} less than minimum operating voltage, values of OUT terminal output is free in the shaded region.

Figure 13

Operation

- 1. Basic operation: CMOS output (Active "L")
 - (1) When the power supply voltage (V_{DD}) is higher than the release voltage (+V_{DET}), the Nch transistor is OFF and the Pch transistor is ON to provide V_{DD} ("H") at the output. Since the Nch transistor N1 in **Figure 14** is OFF, the comparator input voltage is $\frac{(RB+RC) \bullet VDD}{RA+RB+RC}$.
 - (2) When the V_{DD} goes below $+V_{DET}$, the output provides the V_{DD} level, as long as the V_{DD} remains above the detection
 - voltage $-V_{DET}$. When the V_{DD} falls below $-V_{DET}$ (point A in **Figure 15**), the Nch transistor becomes ON, the Pch transistor becomes OFF, and the V_{SS} level appears at the output. At this time the Nch transistor N1 in **Figure 14** becomes ON, the comparator input voltage is changed to $\frac{RB \cdot V_{DD}}{RA + RB}$.
 - (3) When the V_{DD} falls below the minimum operating voltage, the output becomes undefined, or goes to the V_{DD} when the output is pulled up to the V_{DD}.
 - (4) The V_{SS} level appears when the V_{DD} rises above the minimum operating voltage. The V_{SS} level still appears even when the V_{DD} surpasses $-V_{DET}$, as long as it does not exceed the release voltage $+V_{DET}$.
 - (5) When the V_{DD} rises above +V_{DET} (point B in **Figure 15**), the Nch transistor becomes OFF and the Pch transistor becomes ON to provide V_{DD} level at the output.



*1. Parasiteic diode

Figure 14 Operation 1

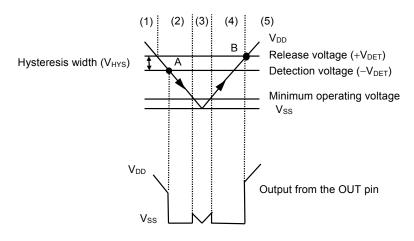
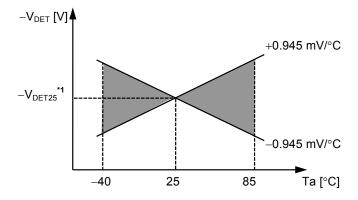


Figure 15 Operation 2

2. Other characteristics

2.1 Temperature characteristics of detection voltage

The shaded area in **Figure 16** shows the temperature characteristics of the detection voltage.



*1. $-V_{DET25}$ is an actual detection voltage value at 25°C.

Figure 16 Temperature characteristics of detection voltage (Example for $-V_{DET} = 2.7 \text{ V}$)

2. 2 Temperature characteristics of release voltage

The temperature change $\frac{\Delta + VDET}{\Delta Ta}$ of the release voltage is calculated by the temperature change $\frac{\Delta - VDET}{\Delta Ta}$ of the

detection voltage as follows:

 $\frac{\Delta + \mathsf{VDET}}{\Delta \mathsf{Ta}} = \frac{+\mathsf{VDET}}{-\mathsf{VDET}} \times \frac{\Delta - \mathsf{VDET}}{\Delta \mathsf{Ta}}$

The temperature changes of the release voltage and the detection voltage have the same sign consequently.

2.3 Temperature characteristics of hysteresis voltage

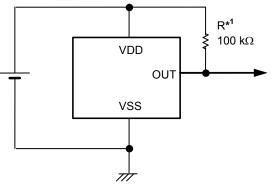
The temperature changes of the hysteresis voltage is expressed as $\frac{\Delta + VDET}{\Delta Ta} - \frac{\Delta - VDET}{\Delta Ta}$ and is calculated as

follows:

Rev.3.1_02

$$\frac{\Delta + VDET}{\Delta Ta} - \frac{\Delta - VDET}{\Delta Ta} = \frac{VHYS}{-VDET} \times \frac{\Delta - VDET}{\Delta Ta}$$

Standard Circuit



*1. R is unnecessary for CMOS output products.

Figure 17

Caution The above connection diagram and constants do not guarantee correct operation. Perform sufficient evaluation using the actual application to set the constants.

Explanation of Terms

1. Detection voltage (-V_{DET}), release voltage (+V_{DET})

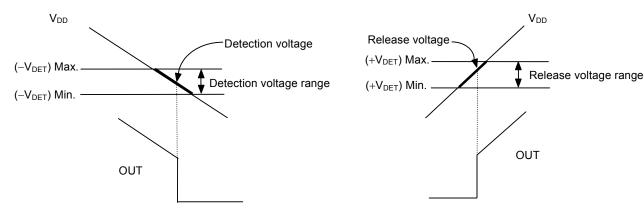
The detection voltage $(-V_{DET})$ is a voltage at which the output turns to "L". The detection voltage varies slightly among products of the same specification. The variation of detection voltage between the specified minimum $(-V_{DET})$ Min. and the maximum $(-V_{DET})$ Max. is called the detection voltage range (Refer to **Figure 18**).

 $\label{eq:Example: For the S-1000C15, the detection voltage lies in the range of 1.485 \leq (-V_{DET}) \leq 1.515.$ This means that some S-1000C15s have 1.485 V for $-V_{DET}$ and some have 1.515 V.

The release voltage is a voltage at which the output turns to "H". The release voltage varies slightly among products of the same specification. The variation of release voltages between the specified minimum ($+V_{DET}$) Min. and the maximum ($+V_{DET}$) Max. is called the release voltage range (Refer to **Figure 19**). The range is calculed from the actual detection voltage ($-V_{DET}$) of a product and is expressed by $-V_{DET} \times 1.03 \le +V_{DET} \le -V_{DET} \times 1.07$.

Example: For the S-1000C15, the release voltage lies in the range of $1.530 \le (+V_{DET}) \le 1.621$. This means that some S-1000C15s have 1.530 V for $+V_{DET}$ and some have 1.621 V.

ULTRA-SMALL PACKAGE HIGH-PRECISION VOLTAGE DETECTOR S-1000 Series







2. Hysteresis width (V_{HYS})

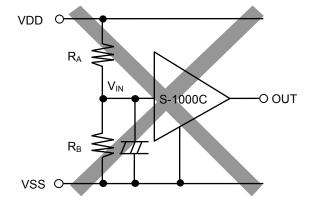
The hysteresis width is the voltage difference between the detection voltage and the release voltage (The voltage at point B - The voltage at point $A = V_{HYS}$ in **Figure 15**). The existence of the hysteresis width prevents malfunction caused by noise on input signal.

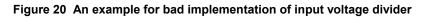
3. Through-type current

The through-type current refers to the current that flows instantaneously at the time of detection and release of a voltage detector. The through-type current is large in CMOS output products, small in Nch open-drain output products.

4. Oscillation

In applications where a resistor is connected to the voltage detector input (**Figure 20**), taking a CMOS active "L" product for example, the through-type current which is generated when the output goes from "L" to "H" (release) causes a voltage drop equal to [through-type current] × [input resistance] across the resistor. When the input voltage drops below the detection voltage ($-V_{DET}$) as a result, the output voltage goes to low level. In this state, the through-type current stops and its resultant voltage drop disappears, and the output goes from "L" to "H". The through-type current is then generated again, a voltage drop appears, and repeating the process finally induces oscillation.



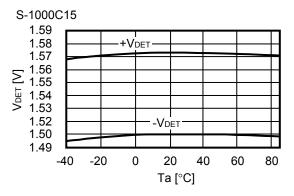


Precautions

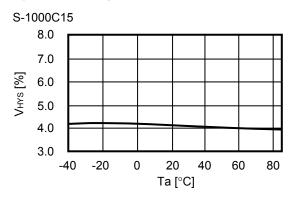
- If the input impedance is high, oscillation may occur due to the through-type current etc. In COMS output products, impedance should not be connected to the input pin. In Nch open drain output products, input impedance is recommended to be 800 Ω or less. However be sure to perform sufficient evaluation under the actual usage conditions for selection, including evaluation of temperature characteristics.
- In CMOS output products oscillation may occur when a pull-down resistor is used, and falling speed of the power supply voltage (V_{DD}) is slow near the detection voltage.
- When designing for mass production using an application circuit described herein, the product deviation and temperature characteristics should be taken into consideration. ABLIC Inc. shall not bear any responsibility for the products on the circuits described herein.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement of the products including this IC upon patents owned by a third party.

Typical Characteristics (Typical Data)

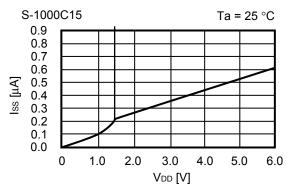
1. Detection voltage (V_{DET}) – temperature (Ta)

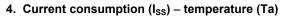


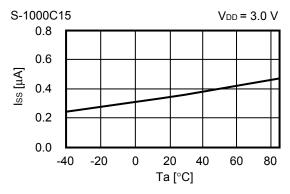
2. Hysteresis voltage width – (V_{HYS}) - temperature (Ta)

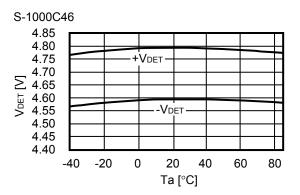


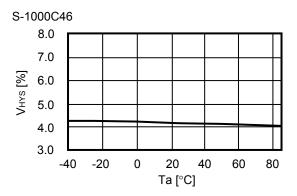
3. Current consumption (I_{ss}) – input voltage (V_{DD})

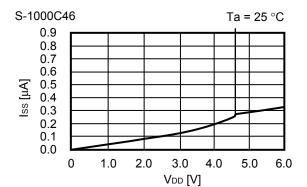


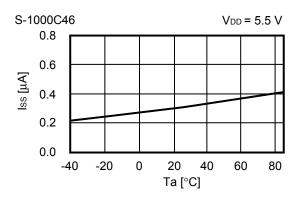






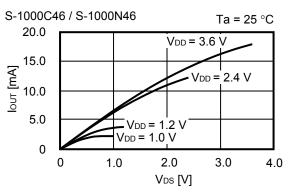




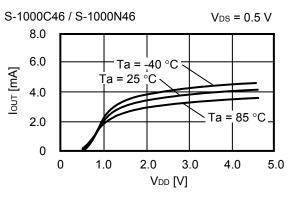


5. Nch transistor output current (I_{OUT}) – V_{DS}

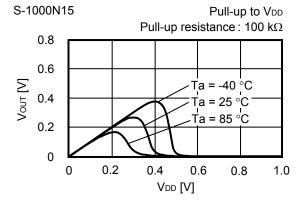
Rev.3.1_02

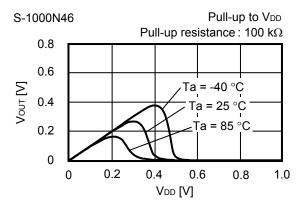


7. Nch transistor output current (I_{OUT})

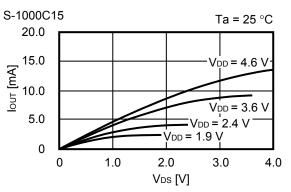


9. Minimum operating voltage - input voltage (V_{DD})

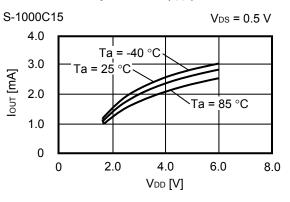




6. Pch transistor output current $(I_{OUT}) - V_{DS}$

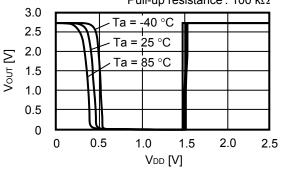


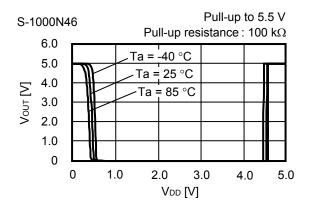
8. Pch transistor output current (I_{OUT})



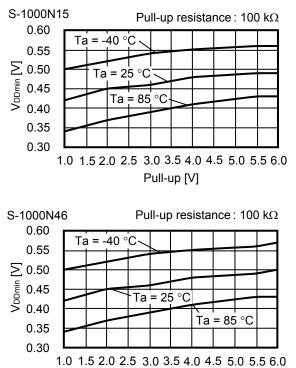


Pull-up to 3.0 V Pull-up resistance : 100 k Ω



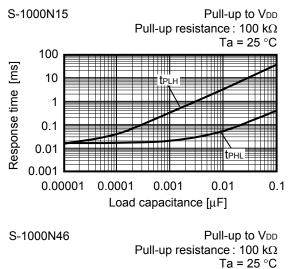


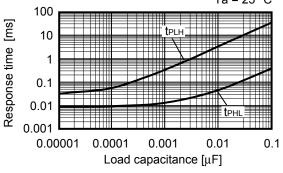
ULTRA-SMALL PACKAGE HIGH-PRECISION VOLTAGE DETECTOR S-1000 Series

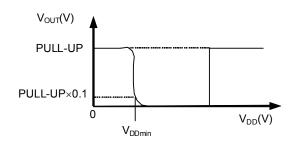


Pull-up [V]

10. Dynamic response - C_{OUT}







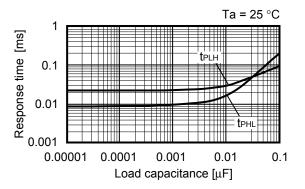
 $\label{eq:constraint} \begin{array}{l} \mbox{Remark} & V_{\mbox{DDmin.}} \mbox{ is defined by the } V_{\mbox{DD}} \mbox{ voltage at which } V_{\mbox{OUT}} \\ & goes \mbox{ below 10\% of pull-up voltage when the } V_{\mbox{DD}} \\ & increase \mbox{ from 0 V.} \end{array}$

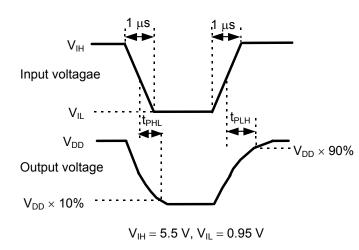


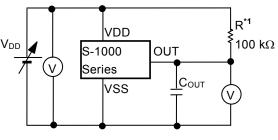
Ta = 25 °C Ta = 25 °C 0.1 0.01 0.01 0.001 0.001 0.001 0.001 0.00 0.00



S-1000C15







*1. R is unnecessary for CMOS output products.

Figure 23 Measurement circuit for response time

Figure 22 Measurement condition for response time

Caution The above connection diagram and constants do not guarantee correct operation. Perform sufficient evaluation using the actual application to set the constants.

Application Circuit Examples

1. Microcomputer reset circuits

If the power supply voltage to a microcomputer falls below the specified level, an unspecified operation may be performed or the contents of the memory register may be lost. When power supply voltage returns to normal, the microcomputer needs to be initialized before normal operations can be done.

Reset circuits protect microcomputers in the event of current being momentarily switched off or lowered.

Reset circuits shown in **Figures 24, 25** can be easily constructed with the help of the S-1000 series, that has low operating voltage, a high-precision detection voltage and hysteresis.

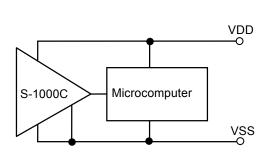
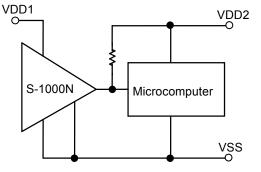


Figure 24 Reset circuit example(S-1000C)



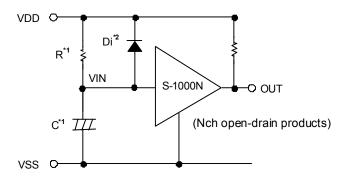
(Only for Nch open-drain products)

Figure 25 Reset circuit example (S-1000N)

Caution The above connection diagram and constants do not guarantee correct operation. Perform sufficient evaluation using the actual application to set the constants.

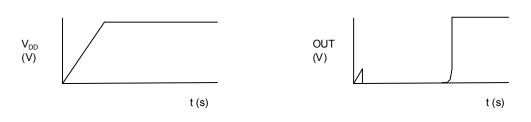
2. Power-on reset circuit

A power-on reset circuit can be constructed using Nch open-drain output product of S-1000 Series.



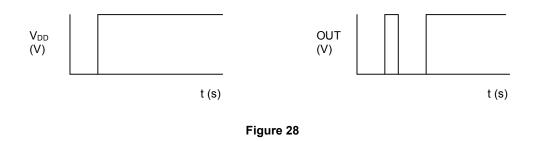
- *1. R should be 75 k Ω or less, and C should be 0.01 μ F or more to prevent oscillation. If C is not connected, R should be 800 Ω or less.
- *2. Diode Di instantaneously discharges the charge stored in the capacitor (C) at the power falling, Di can be removed when the delay of the falling time is not important.







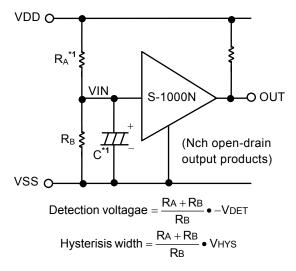
Remark When the power rises sharply as shown in the **Figure 28** left, the output may go to the high level for an instant in the undefined region where the output voltage is undefined since the power voltage is less than the minimum operation voltage.

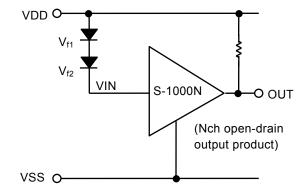


Caution The above connection diagram and constants do not guarantee correct operation. Perform sufficient evaluation using the actual application to set the constants.

3. Change of detection voltage

In Nch open-drain output products of the S-1000 series, detection voltage can be changed using resistance dividers or diodes as shown in **Figures 29 to 30**. In **Figure 29**, hysteresis width also changes.





Detection voltage = $V_{f1}+V_{f2}+(-V_{DET})$

Figure 30

- *1. R_A should be 75 k Ω or less, and C should be 0.01 μ F or more to prevent oscillation. If C is not connected, R_A should be 800 Ω or less.
- Caution If R_A and R_B are large, the hysteresis width may also be larger than the value given by the above equation due to the through-type current (which flows slightly in an Nch open-drain product).

Figure 29

Caution The above connection diagram and constants do not guarantee correct operation. Perform sufficient evaluation using the actual application to set the constants.



Product Code

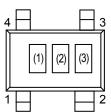
Marking Specifications

(1) SC-82AB



(1) to (3)

: Product code (refer to Product name vs. Product code)



Product name vs. Product code

(a) Nch open-drain output products

Product Name	Pro	Product Code			
Floduct Name	(1)	(2)	(3)		
S-1000N15-N4T1x	Р	L	Α		
S-1000N16-N4T1x	Р	L	В		
S-1000N17-N4T1x	Р	L	С		
S-1000N18-N4T1x	Р	L	D		
S-1000N19-N4T1x	Р	L	E		
S-1000N20-N4T1x	Р	L	F		
S-1000N21-N4T1x	Р	L	G		
S-1000N22-N4T1x	Р	L	Н		
S-1000N23-N4T1x	Р	L	Ι		
S-1000N24-N4T1x	Р	L	J		
S-1000N25-N4T1x	Р	L	K		
S-1000N26-N4T1x	Р	L	L		
S-1000N27-N4T1x	Р	L	М		
S-1000N28-N4T1x	Р	L	Ν		
S-1000N29-N4T1x	Р	L	0		
S-1000N30-N4T1x	Р	L	Р		

(b) CMOS output pro	oducts

	Pro	Product Code		
Product Name	(1)	(2)	(3)	
S-1000C15-N4T1x	Р	К	А	
S-1000C16-N4T1x	Р	К	В	
S-1000C17-N4T1x	Р	К	С	
S-1000C18-N4T1x	Р	К	D	
S-1000C19-N4T1x	Р	К	E	
S-1000C20-N4T1x	Р	К	F	
S-1000C21-N4T1x	Р	К	G	
S-1000C22-N4T1x	Р	К	Н	
S-1000C23-N4T1x	Р	К	I	
S-1000C24-N4T1x	Р	К	J	
S-1000C25-N4T1x	Р	К	K	
S-1000C26-N4T1x	Р	К	L	
S-1000C27-N4T1x	Р	К	М	
S-1000C28-N4T1x	Р	К	Ν	
S-1000C29-N4T1x	Р	К	0	
S-1000C30-N4T1x	Р	К	Р	

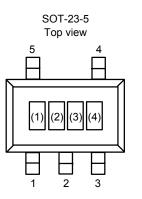
Remark 1. x: G or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

Product Name	Pr	Product Code		
Floduct Name	(1)	(2)	(3)	
S-1000N31-N4T1x	Р	L	Q	
S-1000N32-N4T1x	Р	L	R	
S-1000N33-N4T1x	Р	L	S	
S-1000N34-N4T1x	Р	L	Т	
S-1000N35-N4T1x	Р	L	U	
S-1000N36-N4T1x	Р	L	V	
S-1000N37-N4T1x	Р	L	W	
S-1000N38-N4T1x	Р	L	Х	
S-1000N39-N4T1x	Р	L	Y	
S-1000N40-N4T1x	Р	L	Z	
S-1000N41-N4T1x	Р	L	2	
S-1000N42-N4T1x	Р	L	3	
S-1000N43-N4T1x	Р	L	4	
S-1000N44-N4T1x	Р	L	5	
S-1000N45-N4T1x	Р	L	6	
S-1000N46-N4T1x	Р	L	7	

Product Name	Product Code		ode
Floduct Name	(1)	(2)	(3)
S-1000C31-N4T1x	Р	К	Q
S-1000C32-N4T1x	Р	к	R
S-1000C33-N4T1x	Р	К	S
S-1000C34-N4T1x	Р	К	Т
S-1000C35-N4T1x	Р	К	U
S-1000C36-N4T1x	Р	К	V
S-1000C37-N4T1x	Р	К	W
S-1000C38-N4T1x	Р	К	Х
S-1000C39-N4T1x	Р	К	Y
S-1000C40-N4T1x	Р	К	Z
S-1000C41-N4T1x	Р	К	2
S-1000C42-N4T1x	Р	К	3
S-1000C43-N4T1x	Р	К	4
S-1000C44-N4T1x	Р	К	5
S-1000C45-N4T1x	Р	К	6
S-1000C46-N4T1x	Р	К	7

(2) SOT-23-5



(1) to (3) (4)

: Product code (refer to Product name vs. Product code) : Lot number

Product name vs. Product code

(a) Nch open-drain output products

Product Name	Pro	oduct Co	de
Product Name	(1)	(2)	(3)
S-1000N15-M5T1x	Р	L	Α
S-1000N16-M5T1x	Р	L	В
S-1000N17-M5T1x	Р	L	С
S-1000N18-M5T1x	Р	L	D
S-1000N19-M5T1x	Р	L	E
S-1000N20-M5T1x	Р	L	F
S-1000N21-M5T1x	Р	L	G
S-1000N22-M5T1x	Р	L	Н
S-1000N23-M5T1x	Р	L	I
S-1000N24-M5T1x	Р	L	J
S-1000N25-M5T1x	Р	L	K
S-1000N26-M5T1x	Р	L	L
S-1000N27-M5T1x	Р	L	М
S-1000N28-M5T1x	Р	L	Ν
S-1000N29-M5T1x	Р	L	0
S-1000N30-M5T1x	Р	L	Р

(b) CMOS output products

Product Name	Pro	oduct Co	de
i foddet Name	(1)	(2)	(3)
S-1000C15-M5T1x	Р	К	А
S-1000C16-M5T1x	Р	К	В
S-1000C17-M5T1x	Р	К	С
S-1000C18-M5T1x	Р	К	D
S-1000C19-M5T1x	Р	К	E
S-1000C20-M5T1x	Р	К	F
S-1000C21-M5T1x	Р	К	G
S-1000C22-M5T1x	Р	К	Н
S-1000C23-M5T1x	Р	К	I
S-1000C24-M5T1x	Р	К	J
S-1000C25-M5T1x	Р	К	К
S-1000C26-M5T1x	Р	К	L
S-1000C27-M5T1x	Р	К	М
S-1000C28-M5T1x	Р	К	Ν
S-1000C29-M5T1x	Р	К	0
S-1000C30-M5T1x	Р	К	Р

Remark 1. x: G or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

Product Name (1)(2)(3)S-1000N31-M5T1x Ρ L Q S-1000N32-M5T1x Ρ L R Ρ S-1000N33-M5T1x L S S-1000N34-M5T1x Ρ L Т S-1000N35-M5T1x Ρ U L S-1000N36-M5T1x Ρ L V Ρ S-1000N37-M5T1x L W Ρ S-1000N38-M5T1x L Х Ρ Y S-1000N39-M5T1x L S-1000N40-M5T1x Ρ L Ζ S-1000N41-M5T1x Ρ L 2 Ρ S-1000N42-M5T1x L 3 Ρ S-1000N43-M5T1x L 4 S-1000N44-M5T1x Ρ L 5 S-1000N45-M5T1x Ρ 6 L S-1000N46-M5T1x Ρ 7 L

Product Code

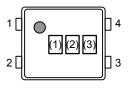
Product Name	Pro	oduct Co	de
FIODUCEName	(1)	(2)	(3)
S-1000C31-M5T1x	Р	К	Q
S-1000C32-M5T1x	Р	К	R
S-1000C33-M5T1x	Р	К	S
S-1000C34-M5T1x	Р	К	Т
S-1000C35-M5T1x	Р	К	U
S-1000C36-M5T1x	Р	К	V
S-1000C37-M5T1x	Р	К	W
S-1000C38-M5T1x	Р	К	Х
S-1000C39-M5T1x	Р	К	Y
S-1000C40-M5T1x	Р	К	Z
S-1000C41-M5T1x	Р	К	2
S-1000C42-M5T1x	Р	К	3
S-1000C43-M5T1x	Р	К	4
S-1000C44-M5T1x	Р	К	5
S-1000C45-M5T1x	Р	К	6
S-1000C46-M5T1x	Р	Κ	7

(3) SNT-4A



(1) to (3)

: Product code (refer to Product name vs. Product code)



Product name vs. Product code

(a) Nch open-drain output products

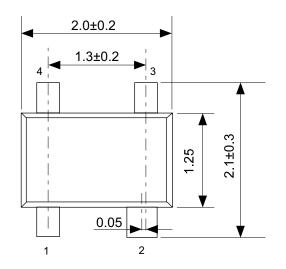
Product Name	Pro	Product Code	
Floudet Name	(1)	(2)	(3)
S-1000N15-I4T1U	Р	L	А
S-1000N16-I4T1U	Р	L	В
S-1000N17-I4T1U	Р	L	С
S-1000N18-I4T1U	Р	L	D
S-1000N19-I4T1U	Р	L	E
S-1000N20-I4T1U	Р	L	F
S-1000N21-I4T1U	Р	L	G
S-1000N22-I4T1U	Р	L	Н
S-1000N23-I4T1U	Р	L	
S-1000N24-I4T1U	Р	L	J
S-1000N25-I4T1U	Р	L	К
S-1000N26-I4T1U	Р	L	L
S-1000N27-I4T1U	Р	L	М
S-1000N28-I4T1U	Р	L	Ν
S-1000N29-I4T1U	Р	L	0
S-1000N30-I4T1U	Р	L	Р

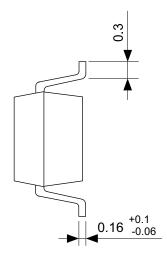
Product Name	Pro	Product Code		
Floduct Name	(1)	(2)	(3)	
S-1000N31-I4T1U	Р	L	Q	
S-1000N32-I4T1U	Р	L	R	
S-1000N33-I4T1U	Р	L	S	
S-1000N34-I4T1U	Р	L	Т	
S-1000N35-I4T1U	Р	L	U	
S-1000N36-I4T1U	Р	L	V	
S-1000N37-I4T1U	Р	L	W	
S-1000N38-I4T1U	Р	L	Х	
S-1000N39-I4T1U	Р	L	Y	
S-1000N40-I4T1U	Р	L	Z	
S-1000N41-I4T1U	Р	L	2	
S-1000N42-I4T1U	Р	L	3	
S-1000N43-I4T1U	Р	L	4	
S-1000N44-I4T1U	Р	L	5	
S-1000N45-I4T1U	Р	L	6	
S-1000N46-I4T1U	Р	L	7	

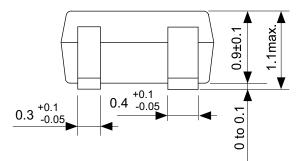
(b) CMOS output products

Product Name	Pro	oduct Co	de
i foddet fyaine	(1)	(2)	(3)
S-1000C15-I4T1U	Р	К	А
S-1000C16-I4T1U	Р	К	В
S-1000C17-I4T1U	Р	К	С
S-1000C18-I4T1U	Р	К	D
S-1000C19-I4T1U	Р	К	E
S-1000C20-I4T1U	Р	К	F
S-1000C21-I4T1U	Р	К	G
S-1000C22-I4T1U	Р	К	Н
S-1000C23-I4T1U	Р	К	I
S-1000C24-I4T1U	Р	К	J
S-1000C25-I4T1U	Р	К	К
S-1000C26-I4T1U	Р	К	L
S-1000C27-I4T1U	Р	К	М
S-1000C28-I4T1U	Р	К	Ν
S-1000C29-I4T1U	Р	К	0
S-1000C30-I4T1U	Р	К	Р

Product Name	Product Code		
Floduct Name	(1)	(2)	(3)
S-1000C31-I4T1U	Р	К	Q
S-1000C32-I4T1U	Р	К	R
S-1000C33-I4T1U	Р	К	S
S-1000C34-I4T1U	Р	К	Т
S-1000C35-I4T1U	Р	К	U
S-1000C36-I4T1U	Р	К	V
S-1000C37-I4T1U	Р	К	W
S-1000C38-I4T1U	Р	К	Х
S-1000C39-I4T1U	Р	К	Y
S-1000C40-I4T1U	Р	К	Z
S-1000C41-I4T1U	Р	К	2
S-1000C42-I4T1U	Р	К	3
S-1000C43-I4T1U	Р	К	4
S-1000C44-I4T1U	Р	К	5
S-1000C45-I4T1U	Р	К	6
S-1000C46-I4T1U	Р	К	7

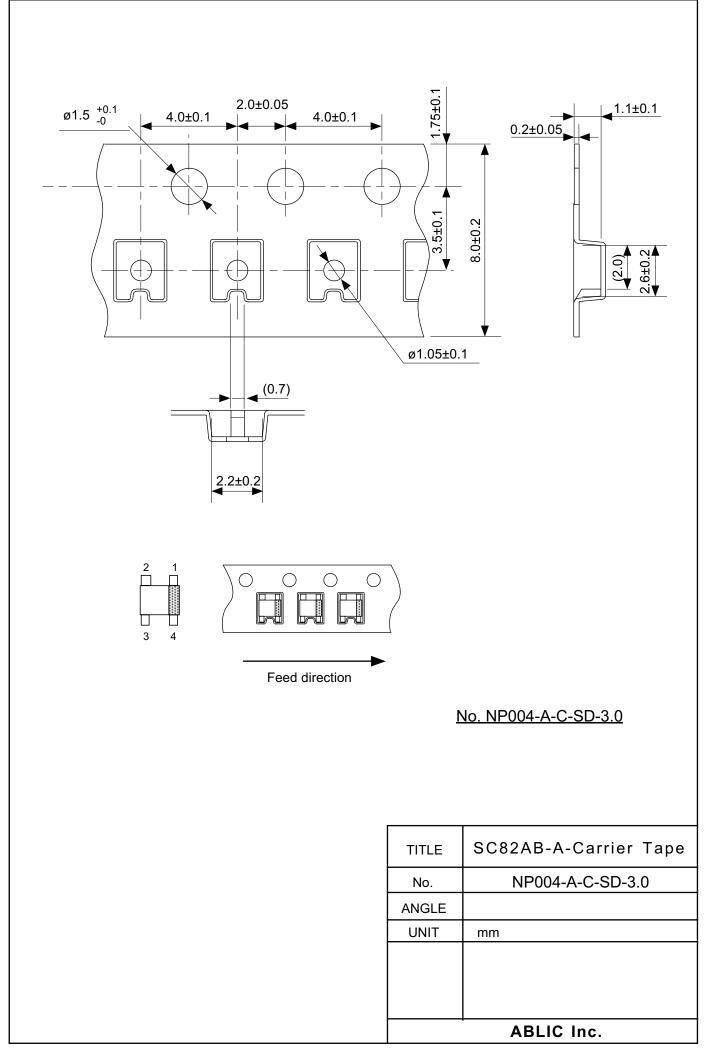


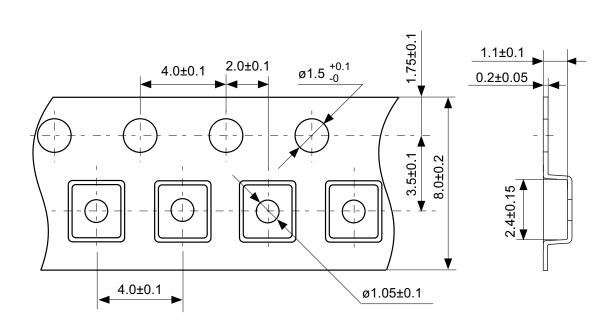


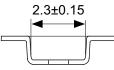


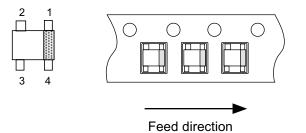
No. NP004-A-P-SD-2.0

TITLE	SC82AB-A-PKG Dimensions	
No.	NP004-A-P-SD-2.0	
ANGLE	$\bigoplus \bigoplus$	
UNIT	mm	
ABLIC Inc.		



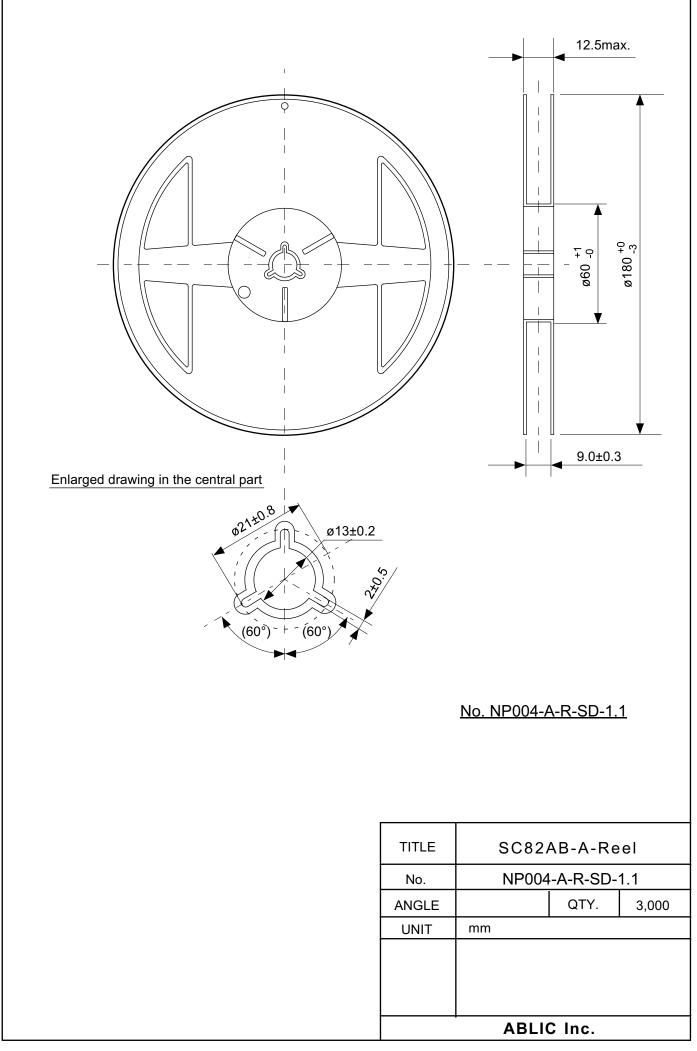


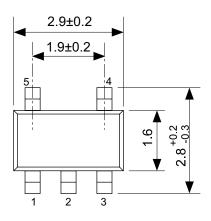


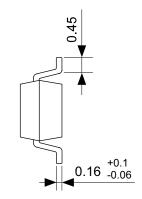


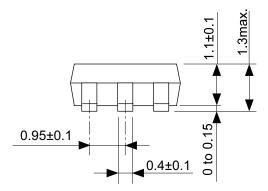
No. NP004-A-C-S1-2.0

TITLE	SC82AB-A-Carrier Tape	
No.	NP004-A-C-S1-2.0	
ANGLE		
UNIT	mm	
ABLIC Inc.		



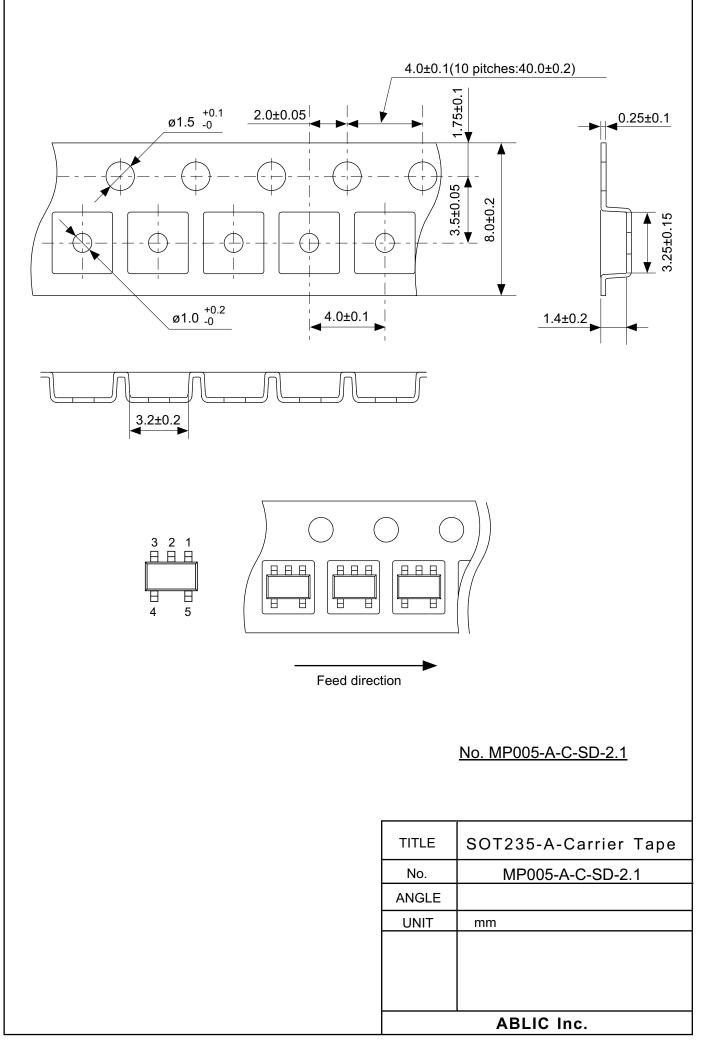


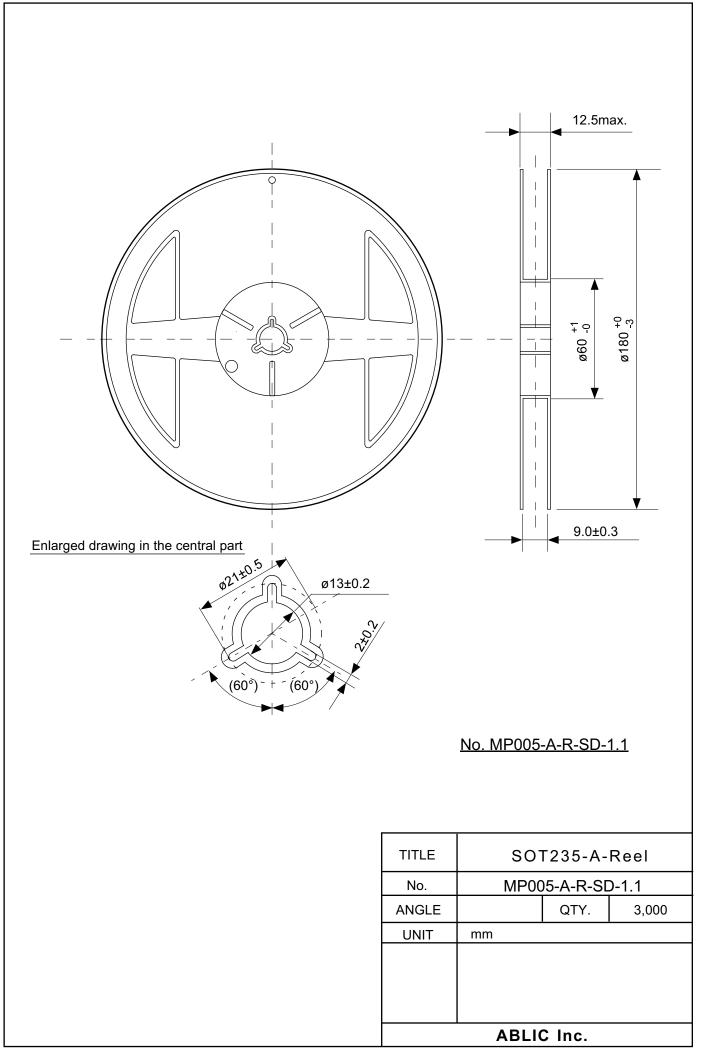


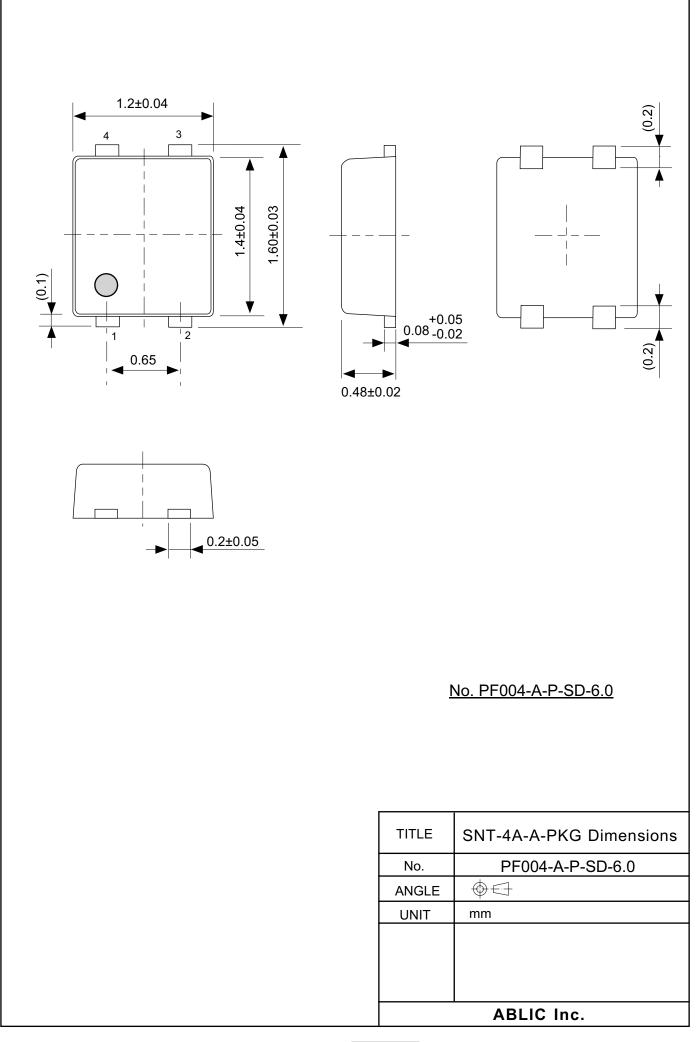


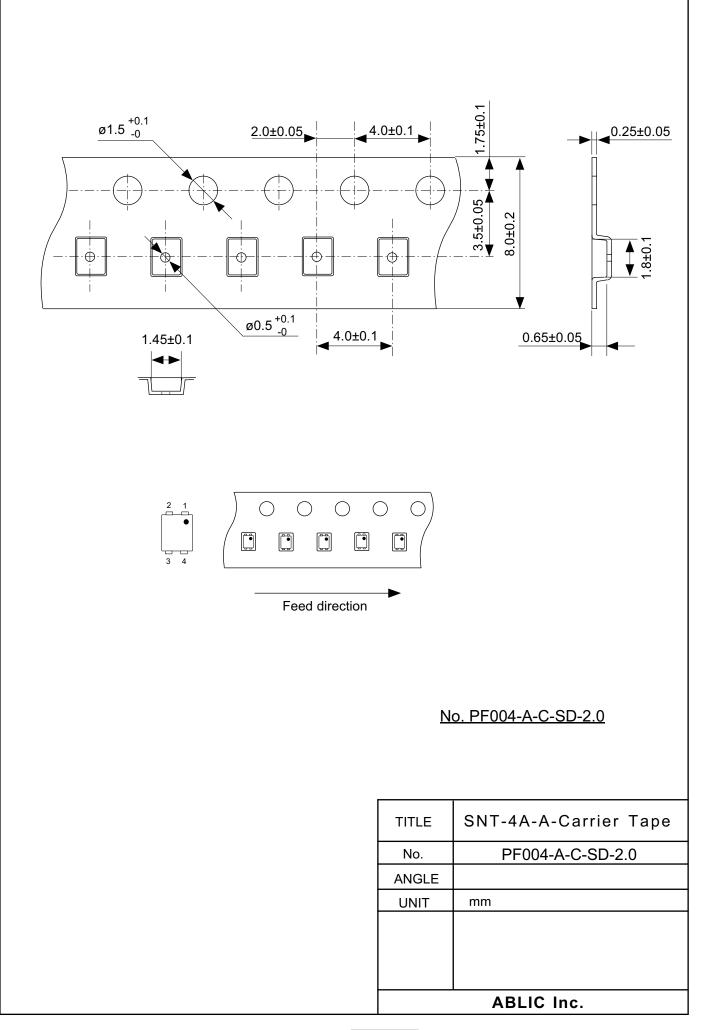
No. MP005-A-P-SD-1.3

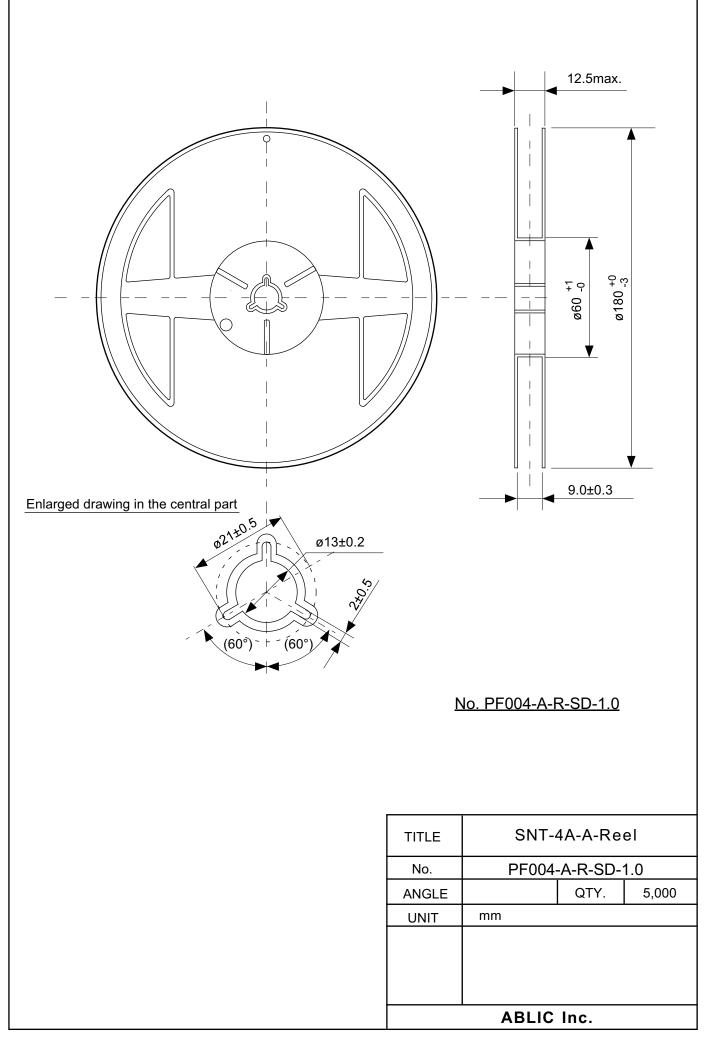
TITLE	SOT235-A-PKG Dimensions	
No.	MP005-A-P-SD-1.3	
ANGLE		
UNIT	mm	
ABLIC Inc.		

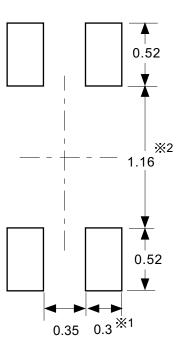












※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 ※2. パッケージ中央にランドパターンを広げないでください (1.10 mm ~ 1.20 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 - パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
 - 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
 - 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。

%1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).

※2. Do not widen the land pattern to the center of the package (1.10 mm to 1.20 mm).

Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.

- 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 - 3. Match the mask aperture size and aperture position with the land pattern.
- 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.10 mm ~ 1.20 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
 - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
 - 4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PF004-A-L-SD-4.1

TITLE	SNT-4A-A -Land Recommendation	
No.	PF004-A-L-SD-4.1	
ANGLE		
UNIT	mm	
ABLIC Inc.		

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